

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE

**Industrial communication networks – Profiles –  
Part 1: Fieldbus profiles**

**Réseaux de communication industriels – Profils –  
Partie 1: Profils de bus de terrain**

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## CONTENTS

FOREWORD.....	13
INTRODUCTION.....	15
1 Scope.....	16
2 Normative references.....	17
3 Definitions.....	21
3.1 Terms and definitions.....	21
3.2 Abbreviations and symbols.....	21
3.2.1 IEC 61158 abbreviations and symbols.....	21
3.2.2 Other abbreviations and symbols.....	21
3.3 Conventions.....	22
3.3.1 Conventions common to all layers.....	22
3.3.2 Physical layer.....	23
3.3.3 Data-link layer.....	23
3.3.4 Application layer.....	24
4 Conformance to communication profiles.....	24
5 Communication Profile Family 1 (FOUNDATION® Fieldbus).....	25
5.1 General overview.....	25
5.2 Profile 1/1 (FF H1).....	26
5.2.1 Physical layer.....	26
5.2.2 Data-link layer.....	41
5.2.3 Application layer.....	105
5.3 Profile 1/2 (FF HSE).....	106
5.3.1 Physical layer.....	106
5.3.2 Data-link layer.....	106
5.3.3 Network layer.....	106
5.3.4 Transport layer.....	106
5.3.5 Application layer.....	107
5.4 Profile 1/3 (FF H2).....	107
5.4.1 Physical layer.....	107
5.4.2 Data-link layer.....	109
5.4.3 Application layer.....	109
6 Communication Profile Family 2 (CIP™).....	109
6.1 General overview.....	109
6.2 Profile 2/1 (ControlNet).....	110
6.2.1 Physical layer.....	110
6.2.2 Data-link layer.....	111
6.2.3 Application layer.....	113
6.3 Profile 2/2 (EtherNet/IP).....	114
6.3.1 Physical layer.....	114
6.3.2 Data-link layer.....	114
6.3.3 Application layer.....	115
6.4 Profile 2/3 (DeviceNet).....	116
6.4.1 Physical layer.....	116
6.4.2 Data-link layer.....	116
6.4.3 Application layer.....	117
7 Communication Profile Family 3 (PROFIBUS & PROFINET).....	119

7.1	General overview .....	119
7.2	Profile 3/1 (PROFIBUS DP) .....	121
7.2.1	Physical layer .....	121
7.2.2	Data-link layer .....	123
7.2.3	Application layer .....	142
7.3	Profile 3/2 (PROFIBUS PA) .....	188
7.3.1	Physical layer .....	188
7.3.2	Data-link layer .....	191
7.3.3	Application layer .....	201
7.4	Profile 3/3 (PROFINET CBA) .....	201
7.4.1	Physical layer .....	201
7.4.2	Data-link layer .....	201
7.4.3	Application layer .....	202
8	Communication Profile Family 4 (P-NET®) .....	203
8.1	General overview .....	203
8.2	Profile 4/1 (P-NET RS-485) .....	203
8.2.1	Physical layer .....	203
8.2.2	Data-link layer .....	204
8.2.3	Application layer .....	205
8.3	Profile 4/2 (P-NET RS-232) .....	206
8.3.1	Physical layer .....	206
8.3.2	Data-link layer .....	207
8.3.3	Application layer .....	207
9	Communication Profile Family 5 (WorldFIP®) .....	208
9.1	General overview .....	208
9.2	Profile 5/1 (WorldFIP) .....	209
9.2.1	Physical layer .....	209
9.2.2	Data-link layer .....	210
9.2.3	Application layer .....	212
9.3	Profile 5/2 (WorldFIP) .....	217
9.3.1	Physical layer .....	217
9.3.2	Data-link layer .....	217
9.3.3	Application layer .....	217
9.4	Profile 5/3 (WorldFIP) .....	221
9.4.1	Physical layer .....	221
9.4.2	Data-link layer .....	222
9.4.3	Application layer .....	222
10	Communication Profile Family 6 (INTERBUS®) .....	223
10.1	General overview .....	223
10.2	Profile 6/1 .....	224
10.2.1	Physical layer .....	224
10.2.2	Data-link layer .....	225
10.2.3	Application layer .....	226
10.3	Profile 6/2 .....	227
10.3.1	Physical layer .....	227
10.3.2	Data-link layer .....	227
10.3.3	Application layer .....	228
10.4	Profile 6/3 .....	230
10.4.1	Physical layer .....	230

10.4.2	Data-link layer .....	230
10.4.3	Application layer .....	231
11	Communication Profile Family 7 (This Clause has been removed) .....	232
12	Communication Profile Family 8 (CC-Link) .....	232
12.1	General overview .....	232
12.1.1	General .....	232
12.1.2	Profile 8/1 .....	232
12.1.3	Profile 8/2 .....	233
12.1.4	Profile 8/3 .....	233
12.2	Profile 8/1 .....	233
12.2.1	Physical layer .....	233
12.2.2	Data-link layer .....	234
12.2.3	Application layer .....	236
12.3	Profile 8/2 .....	239
12.3.1	Physical layer .....	239
12.3.2	Data-link layer .....	239
12.3.3	Application layer .....	239
12.4	Profile 8/3 .....	239
12.4.1	Physical layer .....	239
12.4.2	Data-link layer .....	240
12.4.3	Application layer .....	242
13	Communication Profile Family 9 (HART) .....	244
13.1	General Overview .....	244
13.2	Profile 9/1, universal command .....	244
13.2.1	Physical layer .....	244
13.2.2	Data-link layer .....	244
13.2.3	Application layer .....	244
14	Communication Profile Family 16 (SERCOS) .....	245
14.1	General overview .....	245
14.2	Profile 16/1 (SERCOS I) .....	246
14.2.1	Physical layer selection .....	246
14.2.2	Data-link layer .....	246
14.2.3	Application layer .....	247
14.3	Profile 16/2 (SERCOS II) .....	247
14.3.1	Physical layer .....	247
14.3.2	Data-link layer .....	248
14.3.3	Application layer .....	248
	Annex A (informative) Communication concepts .....	249
	Annex B (informative) Added value of IEC 61784-1 .....	263
	Bibliography .....	264
	Figure 1 – Communication profile families and profiles .....	16
	Figure 2 – Example optical power budget for a 100/140 μm fiber system with a 16/16 optical passive star coupler .....	40
	Figure 3 – CP 3/2 Slave devices usable in applications .....	121
	Figure A.1 – Ring structure .....	261
	Figure A.2 – Topology example .....	262

Table 1 – Relations of Communication Profile Families to type numbers .....	17
Table 2 – Layout of profile (sub)clause selection tables .....	22
Table 3 – Contents of (sub)clause selection tables .....	22
Table 4 – Layout of service selection tables .....	22
Table 5 – Contents of service selection tables .....	23
Table 6 – Layout of parameter selection tables .....	23
Table 7 – Contents of parameter selection tables .....	23
Table 8 – Layout of class attribute selection tables .....	24
Table 9 – Contents of class attribute selection tables .....	24
Table 10 – CPF 1: overview of profile sets .....	25
Table 11 – CP 1/1: PhL selection for communicating devices and their MAUs .....	26
Table 12 – CP 1/1: PhL classification of MAUs and attached devices .....	28
Table 13 – CP 1/1: PhL selection of Clause 16 for devices and their MAUs .....	28
Table 14 – CP 1/1: PhL selection of Clause 12 for devices and their MAUs .....	29
Table 15 – CP 1/1: PhL selection of Clause 21 for devices and their MAUs (denigrated) .....	30
Table 16 – CP 1/1: PhL selection of recommended IS parameters for FF MAU classes 111, 112, 121, 122, 511 and 512 .....	31
Table 17 – CP 1/1: PhL selection for media components .....	32
Table 18 – CP 1/1: PhL selection of imperative IS parameters for media in FISCO systems .....	32
Table 19 – CP 1/1: PhL selection for power supplies .....	33
Table 20 – CP 1/1: PhL selection of power supply types .....	33
Table 21 – CP 1/1: PhL selection of permissible output voltage and IS parameters for FISCO power supplies .....	34
Table 22 – CP 1/1: PhL selection for terminators .....	35
Table 23 – CP 1/1: PhL selection of IS parameters for terminators .....	35
Table 24 – CP 1/1: PhL selection of Clause 12 for intrinsic safety barriers .....	36
Table 25 – CP 1/1: PhL selection of recommended IS parameters for intrinsic safety barriers and galvanic isolators (Entity model only) .....	37
Table 26 – CP 1/1: PhL selection of Clause 12 for intrinsically safe galvanic isolators .....	38
Table 27 – CP 1/1: PhL selection of Clause 15, recommended optical fiber types .....	39
Table 28 – CP 1/1: PhL selection of passive star couplers, recommended maximum insertion loss .....	39
Table 29 – CP 1/1: PhL selection of active star couplers .....	39
Table 30 – CP 1/1: Optical power budget considerations .....	40
Table 31 – CP 1/1: DLL service selection .....	41
Table 32 – CP 1/1: DLL service selection of Clause 5 .....	41
Table 33 – CP 1/1: DLL service selection of 5.4 .....	41
Table 34 – CP 1/1: DLL service selection of 5.4.1 .....	42
Table 35 – CP 1/1: DLL service selection of 5.4.3 .....	42
Table 36 – CP 1/1: DLL service selection of 5.4.6 .....	43
Table 37 – CP 1/1: DLL service selection of Clause 6 .....	43
Table 38 – CP 1/1: DLL service selection of the summary of 6.3, DL-connection QoS .....	44
Table 39 – CP 1/1: DLL service selection of figures 9–14 of 6.4 .....	44

Table 40 – CP 1/1: DLL service selection of 6.5.....	44
Table 41 – CP 1/1: DLL service selection: replacement for Table 13 of 6.5.....	45
Table 42 – CP 1/1: DLL service selection of 6.5, replacement for Table 14.....	45
Table 43 – CP 1/1: DLL service selection of 6.5 for use of addresses for peer DLC.....	46
Table 44 – CP 1/1: DLL service selection of 6.5 for use of addresses for multipeer DLC connect request at publisher.....	46
Table 45 – CP 1/1: DLL service selection of 6.5 for use of addresses for multipeer DLC connect request at subscriber.....	46
Table 46 – CP 1/1: DLL service selection of 6.6.....	46
Table 47 – CP 1/1: DLL service selection: replacement for Table 15 of 6.6.....	47
Table 48 – CP 1/1: DLL service selection of 6.7.....	47
Table 49 – CP 1/1: DLL service selection of 6.7, replacement for Table 16.....	47
Table 50 – CP 1/1: DLL service selection of 6.7, replacement for Table 17.....	47
Table 51 – CP 1/1: DLL service selection of 6.7, replacement for Table 18.....	48
Table 52 – CP 1/1: DLL service selection of Clause 7.....	48
Table 53 – CP 1/1: DLL service selection of 7.5, replacement for Table 23.....	49
Table 54 – CP 1/1: DLL service selection of Clause 8.....	49
Table 55 – CP 1/1: DLL service selection of 8.5, replacement for Table 28.....	49
Table 56 – CP 1/1: DLL protocol selection.....	50
Table 57 – CP 1/1: DLL protocol selection of Clause 4.....	50
Table 58 – CP 1/1: DLL protocol selection of 4.3.....	51
Table 59 – CP 1/1: DLL protocol selection of 4.3.2.1 for use of link designators.....	51
Table 60 – CP 1/1: DLL protocol selection of 4.3.2.2 for use of node designators.....	51
Table 61 – CP 1/1: DLL protocol selection of 4.3.3.1 for predefined flat non-local DL-addresses.....	51
Table 62 – CP 1/1: DLL protocol selection of 4.3.3.2 for predefined flat link-local DL-addresses.....	52
Table 63 – CP 1/1: DLL protocol selection of 4.3.3.3 for predefined node-local DL-addresses.....	52
Table 64 – CP 1/1: DLL protocol selection of 4.7.....	52
Table 65 – CP 1/1: DLL protocol selection of 4.7.4.....	53
Table 66 – CP 1/1: DLL protocol selection of 4.7.5.....	54
Table 67 – CP 1/1: DLL protocol selection of Clause 6.....	55
Table 68 – CP 1/1: DLL protocol selection, replacement for Table 10 of 6.0.....	56
Table 69 – CP 1/1: DLL protocol selection of 6.5.....	57
Table 70 – CP 1/1: DLL protocol selection of 6.7.....	60
Table 71 – CP 1/1: DLL protocol selection of 6.8.....	64
Table 72 – CP 1/1: DLL protocol selection of 6.11.....	65
Table 73 – CP 1/1: DLL protocol selection of 6.12.....	65
Table 74 – CP 1/1: DLL protocol selection of 6.15.....	66
Table 75 – CP 1/1: DLL protocol selection of 6.20.....	67
Table 76 – CP 1/1: DLL protocol selection of Clause 7.....	68
Table 77 – CP 1/1: DLL protocol selection of 7.4.....	69
Table 78 – CP 1/1: DLL protocol selection of Clause 8.....	70
Table 79 – CP 1/1: DLL protocol selection of 8.2.....	71



Table 80 – CP 1/1: DLL protocol selection of 8.2.2 .....	81
Table 81 – CP 1/1: DLL protocol selection of 8.3 .....	93
Table 82 – CP 1/1: DLL protocol selection of 8.4 .....	93
Table 83 – CP 1/1: DLL protocol selection of Clause 9.....	95
Table 84 – CP 1/1: DLL protocol selection of 9.3 .....	96
Table 85 – CP 1/1: DLL protocol selection of 9.3.5 .....	98
Table 86 – CP 1/1: DLL protocol selection of 9.3.5.2.2, replacement for element encoding.....	99
Table 87 – CP 1/1: DLL protocol selection of Clause 10.....	99
Table 88 – CP 1/1: DLL protocol selection of 10.2 .....	99
Table 89 – CP 1/1: DLL protocol selection of 10.3 .....	100
Table 90 – CP 1/1: DLL protocol selection of 10.3.7, specification of errors .....	102
Table 91 – CP 1/1: DLL protocol selection of 10.4 .....	103
Table 92 – CP 1/1: DLL protocol selection of 10.5 .....	104
Table 93 – CP 1/1: DLL protocol selection of 10.6 .....	104
Table 94 – CP 1/1: AL service selection.....	105
Table 95 – CP 1/1: AL data type selection of Clause 4.....	105
Table 96 – CP 1/1: AL protocol selection .....	106
Table 97 – CP 1/2: AL service selection.....	107
Table 98 – CP 1/2: AL protocol selection.....	107
Table 99 – CP 1/3: PhL selection for FF H2 devices.....	108
Table 100 – CP 1/3: PhL selection for FF H2 media and related components.....	109
Table 101 – CPF 2: overview of profile sets.....	110
Table 102 – CP 2/1: PhL selection.....	111
Table 103 – CP 2/1: DLL service selection.....	112
Table 104 – CP 2/1: DLL protocol selection .....	112
Table 105 – CP 2/1: DLL protocol selection of management objects .....	112
Table 106 – CP 2/1: AL service selection.....	113
Table 107 – CP 2/1: AL protocol selection .....	113
Table 108 – CP 2/2: DLL protocol selection .....	114
Table 109 – CP 2/2: DLL protocol selection of management objects .....	115
Table 110 – CP 2/2: AL service selection.....	115
Table 111 – CP 2/2: AL protocol selection .....	116
Table 112 – CP 2/3: DLL protocol selection .....	117
Table 113 – CP 2/3: DLL protocol selection of management objects .....	117
Table 114 – CP 2/3: AL service selection.....	118
Table 115 – CP 2/3: AL protocol selection .....	119
Table 116 – CPF 3: overview of profile sets.....	120
Table 117 – CP 3/1: PhL selection.....	122
Table 118 – CP 3/1: PhL selection of Clause 3 .....	123
Table 119 – CP 3/1: PhL selection of Clause 4 .....	123
Table 120 – CP 3/1: General DLL service selection .....	124
Table 121 – CP 3/1: DLL service selection for DP-V0 master (class 1).....	124

Table 122 – CP 3/1: DLM service selection for DP-V0 master (class 1).....	125
Table 123 – CP 3/1: DLL service selection for DP-V1 master (class 1).....	126
Table 124 – CP 3/1: DLM service selection for DP-V1 master (class 1).....	127
Table 125 – CP 3/1: DLL service selection for DP-V0 master (class 2).....	127
Table 126 – CP 3/1: DLL service selection for DP-V1 master (class 2).....	128
Table 127 – CP 3/1: DLL service selection for DP-V0 slave .....	129
Table 128 – CP 3/1: DLM service selection for DP-V0 slave .....	130
Table 129 – CP 3/1: DLL service selection for DP-V1 slave .....	131
Table 130 – CP 3/1: DLM service selection for DP-V1 slave .....	132
Table 131 – CP 3/1: General DLL protocol selection .....	132
Table 132 – CP 3/1: DLL protocol selection of Clause 5.....	133
Table 133 – CP 3/1: DLL protocol selection of Clause 6.....	133
Table 134 – CP 3/1: DLL protocol selection of Clause 7.....	134
Table 135 – CP 3/1: Time variable selection for DP-V0 master (class 1).....	134
Table 136 – CP 3/1: Timer and counter selection for DP-V0 master (class 1).....	135
Table 137 – CP 3/1: DLPDU selection for DP-V0 master (class 1) .....	135
Table 138 – CP 3/1: MAC state selection for DP-V0 master (class 1).....	135
Table 139 – CP 3/1: Time selection for DP-V1 master (class 1).....	136
Table 140 – CP 3/1: Timer and counter selection for DP-V1 master (class 1).....	136
Table 141 – CP 3/1: DLPDU selection for DP-V1 master (class 1) .....	137
Table 142 – CP 3/1: MAC state selection for DP-V1 master (class 1).....	137
Table 143 – CP 3/1: CS protocol selection for DP-V1 master (class 1).....	137
Table 144 – CP 3/1: Time selection for DP-V1 master (class 2) .....	138
Table 145 – CP 3/1: Timer and counter selection for DP-V1 master (class 2).....	138
Table 146 – CP 3/1: DLPDU selection for DP-V1 master (class 2) .....	139
Table 147 – CP 3/1: Time selection for DP-V0 slave .....	139
Table 148 – CP 3/1: Timer and counter selection for DP-V0 slave .....	140
Table 149 – CP 3/1: DLPDU selection for DP-V0 slave .....	140
Table 150 – CP 3/1: MAC state selection for DP-V0 slave .....	140
Table 151 – CP 3/1: Time selection for DP-V1 slave .....	141
Table 152 – CP 3/1: Timer and counter selection for DP-V1 slave .....	141
Table 153 – CP 3/1: DLPDU selection for DP-V1 slave .....	142
Table 154 – CP 3/1: CS protocol selection for DP-V1 slave .....	142
Table 155 – CP 3/1, 3/2: AL service selection.....	142
Table 156 – CP 3/1, 3/2: AL service selection of data types.....	143
Table 157 – CP 3/1, 3/2: AL service selection of Clause 6 .....	144
Table 158 – CP 3/1, 3/2: AL service selection of I/O data ASE.....	145
Table 159 – CP 3/1, 3/2: AL service selection of Diagnosis ASE.....	145
Table 160 – CP 3/1, 3/2: AL service selection of Context ASE .....	146
Table 161 – CP 3/1, 3/2: AL service selection of Management ASE .....	146
Table 162 – CP 3/1, 3/2: AL service selection of AR ASE .....	147
Table 163 – CP 3/1, 3/2: AL service selection of Clause 6 .....	148
Table 164 – CP 3/1, 3/2: AL service selection of Process data ASE.....	148

Table 165 – CP 3/1, 3/2: AL service selection of I/O data ASE .....	148
Table 166 – CP 3/1, 3/2: AL service selection of Alarm ASE .....	149
Table 167 – CP 3/1, 3/2: AL service selection of Context ASE .....	149
Table 168 – CP 3/1, 3/2: AL service selection of Load region ASE .....	149
Table 169 – CP 3/1, 3/2: AL service selection of Function invocation ASE .....	149
Table 170 – CP 3/1, 3/2: AL service selection of Time ASE .....	150
Table 171 – CP 3/1, 3/2: AL service selection of AR ASE .....	150
Table 172 – CP 3/1, 3/2: AL service selection of Clause 6 .....	151
Table 173 – CP 3/1, 3/2: AL service selection of I/O data ASE .....	151
Table 174 – CP 3/1, 3/2: AL service selection of Diagnosis ASE .....	152
Table 175 – CP 3/1, 3/2: AL service selection of Context ASE .....	152
Table 176 – CP 3/1, 3/2: AL service selection of Management ASE .....	152
Table 177 – CP 3/1, 3/2: AL service selection of AR ASE .....	153
Table 178 – CP 3/1, 3/2: AL service selection of Clause 6 .....	154
Table 179 – CP 3/1, 3/2: AL service selection of Process data ASE .....	154
Table 180 – CP 3/1, 3/2: AL service selection of Context ASE .....	154
Table 181 – CP 3/1, 3/2: AL service selection of Load region ASE .....	155
Table 182 – CP 3/1, 3/2: AL service selection of Function invocation ASE .....	155
Table 183 – CP 3/1, 3/2: AL service selection of Time ASE .....	155
Table 184 – CP 3/1, 3/2: AL service selection of AR ASE .....	156
Table 185 – CP 3/1, 3/2: AL service selection of Clause 6 .....	157
Table 186 – CP 3/1, 3/2: AL service selection of I/O data ASE .....	157
Table 187 – CP 3/1, 3/2: AL service selection of Diagnosis ASE .....	158
Table 188 – CP 3/1, 3/2: AL service selection of Context ASE .....	158
Table 189 – CP 3/1, 3/2: AL service selection of AR ASE .....	159
Table 190 – CP 3/1, 3/2: AL service selection of Clause 6 .....	160
Table 191 – CP 3/1, 3/2: AL service selection of Process data ASE .....	160
Table 192 – CP 3/1, 3/2: AL service selection of I/O data ASE .....	160
Table 193 – CP 3/1, 3/2: AL service selection of diagnosis ASE .....	161
Table 194 – CP 3/1, 3/2: AL service selection of Alarm ASE .....	161
Table 195 – CP 3/1, 3/2: AL service selection of Context ASE .....	162
Table 196 – CP 3/1, 3/2: AL service selection of Load region ASE .....	162
Table 197 – CP 3/1, 3/2: AL service selection of Function invocation ASE .....	163
Table 198 – CP 3/1, 3/2: AL service selection of Time ASE .....	163
Table 199 – CP 3/1, 3/2: AL service selection of AR ASE .....	164
Table 200 – CP 3/1, 3/2: AL protocol selection .....	165
Table 201 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11 .....	165
Table 202 – CP 3/1, 3/2: AL protocol selection of APDUs .....	167
Table 203 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives .....	167
Table 204 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives .....	168
Table 205 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11 .....	168
Table 206 – CP 3/1, 3/2: AL protocol selection of APDUs .....	170
Table 207 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives .....	171

Table 208 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives.....	172
Table 209 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 6 .....	172
Table 210 – CP 3/1, 3/2: AL protocol selection of APDUs .....	174
Table 211 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives .....	174
Table 212 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives.....	175
Table 213 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11 .....	175
Table 214 – CP 3/1, 3/2: AL protocol selection of APDUs .....	176
Table 215 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives .....	178
Table 216 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives.....	178
Table 217 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11 .....	179
Table 218 – CP 3/1, 3/2: AL protocol selection of APDU selection .....	180
Table 219 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives .....	181
Table 220 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives.....	181
Table 221 – CP 3/1, 3/2: AL protocol selection of Clause 4 to 11 .....	182
Table 222 – CP 3/1, 3/2: AL protocol selection of APDUs .....	184
Table 223 – CP 3/1, 3/2: AL protocol selection of FSPM services primitives .....	185
Table 224 – CP 3/1, 3/2: AL protocol selection of DMPM services primitives.....	186
Table 225 – CP 3/2: PhL selection .....	188
Table 226 – CP 3/2: PhL selection of Clause 12 for devices and their MAUs.....	190
Table 227 – CP 3/2: PhL selection of recommended IS parameters .....	190
Table 228 – CP 3/2: PhL selection of Clause 21 for devices and their MAUs.....	191
Table 229 – CP 3/2: General DLL protocol selection.....	192
Table 230 – CP 3/2: DLL protocol selection of Clause 4.....	192
Table 231 – CP 3/2: DLL protocol selection of Clause 5.....	193
Table 232 – CP 3/2: DLL protocol selection of Clause 6.....	193
Table 233 – CP 3/2: DLL protocol selection of Clause 7.....	194
Table 234 – CP 3/2: Time variable selection for DP-V0 master (class 1).....	194
Table 235 – CP 3/2: Timer and counter selection for DP-V0 master (class 1).....	195
Table 236 – CP 3/2: DLPDU selection for DP-V0 master (class 1) .....	195
Table 237 – CP 3/2: Time variable selection for DP-V1 master (class 1).....	196
Table 238 – CP 3/2: Timer and counter selection for DP-V1 master (class 1).....	196
Table 239 – CP 3/2: DLPDU selection for DP-V1 master (class 1) .....	197
Table 240 – CP 3/2: Time variable selection for DP-V1 master (class 2).....	197
Table 241 – CP 3/2: Timer and counter selection for DP-V1 master (class 2).....	198
Table 242 – CP 3/2: DLPDU selection for DP-V1 master (class 2) .....	198
Table 243 – CP 3/2: Time variable selection for DP-V0 slave.....	199
Table 244 – CP 3/2: Timer and counter selection for DP-V0 slave .....	199
Table 245 – CP 3/2: DLPDU selection for DP-V0 slave .....	199
Table 246 – CP 3/2: Time variable selection for DP-V1 slave.....	200
Table 247 – CP 3/2: Timer and counter selection for DP-V1 slave .....	200
Table 248 – CP 3/2: DLPDU selection for DP-V1 slave .....	201
Table 249 – CP 3/3: AL service selection.....	202
Table 250 – CP 3/3: AL protocol selection .....	202

Table 251 – CP 4/1: PhL selection .....	204
Table 252 – CP 4/1: DLL service selection .....	205
Table 253 – CP 4/1: DLL protocol selection .....	205
Table 254 – CP 4/1: AL service selection .....	205
Table 255 – CP 4/1: AL protocol selection .....	206
Table 256 – CP 4/2: PhL selection .....	207
Table 257 – CPF 5: overview of profile sets .....	208
Table 258 – CPF 5: PhL selection .....	209
Table 259 – CPF 5: DLL service selection .....	210
Table 260 – CPF 5: DLL service selection of Clause 4 .....	210
Table 261 – CPF 5: DLL protocol selection .....	211
Table 262 – CPF 5: DLL protocol selection of variables and resources .....	211
Table 263 – CPF 5: DLL protocol selection of DLPDUs .....	212
Table 264 – CP 5/1: AL service selection .....	212
Table 265 – CP 5/1: AL service selection of ASEs .....	212
Table 266 – CPF 5: AL service selection of MPS ASEs .....	213
Table 267 – CPF 5: AL service selection of variable elements .....	213
Table 268 – CPF 5: AL service selection of produced variable elements .....	213
Table 269 – CPF 5: AL service selection of consumed variable elements .....	213
Table 270 – CP 5/1: AL service selection of MPS services .....	214
Table 271 – CP 5/1, 5/2: AL service selection of A_Readloc service parameters .....	214
Table 272 – CP 5/1, 5/2: AL service selection of A_Readfar service parameters .....	214
Table 273 – CP 5/1, 5/2: AL service selection of A_Read service parameters .....	214
Table 274 – CP 5/1: AL service selection of MCS service classes .....	214
Table 275 – CP 5/1: AL service selection of QoS .....	215
Table 276 – CP 5/1: AL service selection of MCS services .....	215
Table 277 – CP 5/1, 5/2: AL service selection of A_Data parameters .....	215
Table 278 – CP 5/1: AL protocol selection .....	215
Table 279 – CPF 5/1: AL protocol selection of MPS data types .....	216
Table 280 – CPF 5/1: AL protocol selection of MPS PDUs .....	216
Table 281 – CPF 5/1: AL protocol selection of MPS encoding rules .....	216
Table 282 – CP 5/1, 5/2: AL protocol selection of MCS PDUs .....	216
Table 283 – CP 5/1: AL protocol selection of MCS state machines .....	217
Table 284 – CP 5/2: AL service selection .....	217
Table 285 – CP 5/2: AL service selection of ASEs .....	217
Table 286 – CP 5/2: AL service selection of MPS services .....	218
Table 287 – CP 5/2: AL service selection of MCS service classes .....	218
Table 288 – CP 5/2: AL service selection of QoS .....	218
Table 289 – CP 5/2: AL service selection of MCS services .....	218
Table 290 – CP 5/2: AL service selection of domain services .....	219
Table 291 – CP 5/2: AL service selection of domain object attributes .....	219
Table 292 – CP 5/2: AL service selection of program services .....	219
Table 293 – CP 5/2: AL service selection of program object attributes .....	219

Table 294 – CP 5/2: AL service selection of variable services .....	220
Table 295 – CP 5/2: AL service selection of variable classes .....	220
Table 296 – CP 5/2: AL service selection of variable class attributes .....	220
Table 297 – CP 5/2: AL protocol selection .....	220
Table 298 – CP 5/2: AL protocol selection of MCS state machines.....	221
Table 299 – CP 5/2: AL protocol selection of sub-MMS coding rules .....	221
Table 300 – CP 5/2: AL protocol selection of sub-MMS PDUs .....	221
Table 301 – CP 5/3: AL service selection.....	222
Table 302 – CP 5/3: AL service selection of ASEs .....	222
Table 303 – CP 5/3: AL protocol selection .....	222
Table 304 – CPF 6: device CP identifier assignment.....	223
Table 305 – CPF 6: PhL selection.....	224
Table 306 – CP 6/1: DLL service selection, assignment of DLL services to device types.....	225
Table 307 – CPF 6: DLL protocol selection of data widths supported by master.....	226
Table 308 – CP 6/1: AL service selection, assignment of AL services to device types.....	227
Table 309 – CP 6/2: DLL service selection, assignment of DLL services to device types.....	228
Table 310 – CP 6/2: AL service selection, assignment of AL services to device types.....	229
Table 311 – CP 6/2: AL service selection of AR-Data-Send-Acknowledge service parameters .....	229
Table 312 – CP 6/3: DLL service selection, assignment of DLL services to device types.....	230
Table 313 – CP 6/3: AL service selection, assignment of AL services to device types.....	231
Table 314 – CP 8/1 transmission support level .....	233
Table 315 – CP 8/1 PhL selection .....	234
Table 316 – CP 8/1 DLL services selection .....	234
Table 317 – CP 8/1 DLL protocol selection .....	235
Table 318 – CP 8/1 AL services selection .....	237
Table 319 – CP 8/1 AL protocol selection .....	238
Table 320 – CP 8/2 DLL protocol selection .....	239
Table 321 – CP 8/3 PhL selection .....	240
Table 322 – CP 8/3 DLL services selection .....	240
Table 323 – CP 8/3 DLL protocol selection .....	241
Table 324 – CP 8/3 AL services selection .....	242
Table 325 – CP 8/3 AL protocol selection .....	243
Table 326 – CP 9/1: AL service selection.....	245
Table 327 – CP 9/1: AL protocol selection .....	245
Table 328 – CP 16/1: PhL selection .....	246
Table 329 – CP 16/1: DLL protocol selection .....	247
Table 330 – CP 16/1: AL service selection.....	247
Table 331 – CP 16/2: PhL selection .....	248
Table A.1 – Number of devices per CP16/1 and CP16/2 systems (examples) .....	262

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**INDUSTRIAL COMMUNICATION NETWORKS –  
PROFILES –****Part 1: Fieldbus profiles**

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